TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MH4040FK

12-Stage Ripple-Carry Binary Counter

The TC7MH4040FK is an advanced high speed CMOS 12-stage ripple-carry binary counter fabricated with silicon gate $\rm C^2MOS$ technology.

It achieves the high speed operation similar to equivalent bipolar schottky TTL while maintaining the CMOS low power dissipation.

Setting CLR to high resets the counter to low.

A negative transition on the $\overline{\mbox{CK}}$ input brings one increment into the counter.

This counter provides all divided output stages, and at Q12, a 1/4096 divided frequency will be output.

An input protection circuit ensures that 0 to $5.5~\rm V$ can be applied to the input pins without regard to the supply voltage. This device can be used to interface $5~\rm V$ to $3~\rm V$ systems and two

VSSOP16-P-0030-0.50

Weight: 0.02 g (typ.)

supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

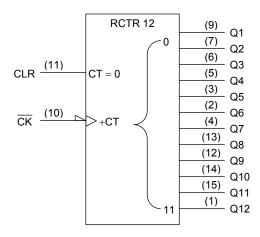
Features

- High speed: $f_{max} = 210 \text{ MHz}$ (typ.) (V_{CC} = 5 V)
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max) (Ta} = 25 ^{\circ}\text{C)}$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: $V_{CC (opr)} = 2 \sim 5.5 \text{ V}$
- Low noise: V_{OLP} = 1.5 V (max)
- Pin and function compatible with 74HC4040

Pin Assignment (top view)

Q12 16 V_{CC} Q6 Q11 2 15 Q5 Q10 Q7 Q8 Q4 Q9 Q3 CLR $\overline{\mathsf{CK}}$ Q2 10 GND 8 Q1

IEC Logic Level

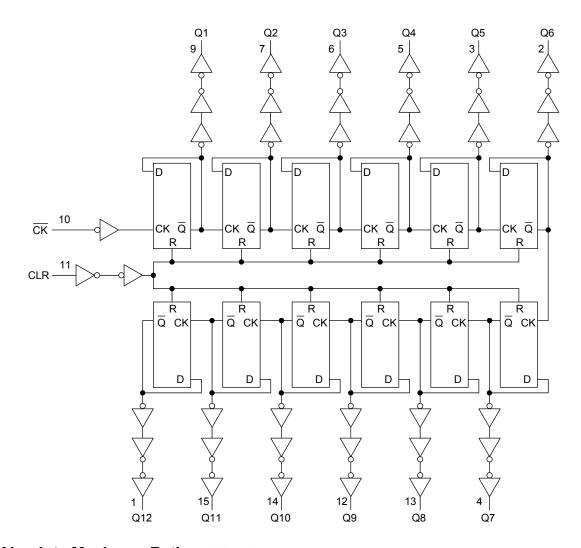


Truth Table

CK	CLR	Outputs
Х	Н	All outputs = "L"
	L	No change
	L	Advance to next state

X: Don't care

System Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7.0	V
DC input voltage	V _{IN}	-0.5~7.0	V
DC output voltage	V _{OUT}	-0.5~V _{CC} + 0.5	V
Input diode current	lık	-20	mA
Output diode current	I _{OK}	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	I _{CC}	±100	mA
Power dissipation	P _D	180	mW
Storage temperature	T _{stg}	-65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, may lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

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Operating Ranges (Note)

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Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0~5.5	V
Input voltage	V _{IN}	0~5.5	٧
Output voltage	V _{OUT}	0~V _{CC}	٧
Operating temperature	T _{opr}	-40~85	°C
Input rise and fall time	dt/dv	$0\sim100~(V_{CC}=3.3\pm0.3~V)$	ns/V
input rise and rail time	uuuv	$0\sim20 \ (V_{CC}=5\pm0.5 \ V)$	113/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics		Cumbal	Symbol Test Condition		ndition		Ta = 25°C			Ta = -40~85°C	
Cildial	Steristics	Symbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
High level			_		2.0	1.50	_	_	1.50	_	V
		V _{IH}			3.0~5.5	V _{CC} × 0.7	_		V _{CC} × 0.7	-	
Input voltage								0.50	_	0.50	V
	Low level	V _{IL}			3.0~5.5	l	l	V _{CC} × 0.3	_	V _{CC} × 0.3	
		Vон	V _{IN} = V _{IH} or V _{IL}	Ι _{ΟΗ} = -50 μΑ	2.0	1.9	2.0		1.9		V
	High level				3.0	2.9	3.0	_	2.9	_	
					4.5	4.4	4.5	_	4.4	_	
				I _{OH} = -4 mA	3.0	2.58	_	_	2.48	_	
Output				I _{OH} = -8 mA	4.5	3.94			3.80		
voltage			V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0		0	0.1	_	0.1	V
		V _{OL}			3.0		0	0.1	_	0.1	
	Low level				4.5	_	0	0.1	_	0.1	
				I _{OL} = 4 mA	3.0	_	_	0.36	_	0.44	
				I _{OL} = 8 mA	4.5		_	0.36	_	0.44	
Input leakage	current	I _{IN}	V _{IN} = 5.5 V or GND		0~5.5			±0.1	_	±1.0	μΑ
Quiescent sup	ply current	Icc	I _{CC} V _{IN} = V _{CC} or GND		5.5	_	_	4.0		40.0	μА

Timing Requirements (Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Symbol Test Condition		Ta = 25°C		Ta = -40~85°C	Unit	
Characteristics Symbol		rest Condition	V _{CC} (V)	Тур.	Limit	Limit	Offic	
Minimum pulse width	t _{w (L)}		3.3 ± 0.3	_	5.0	5.0	ns	
(CK)	tw (H)	_	5.0 ± 0.5	_	5.0	5.0	115	
Minimum pulse width	t		3.3 ± 0.3	_	5.0	5.0	ns	
(CLR)	tw (H)	_	5.0 ± 0.5	_	5.0	5.0	115	
Minimum removal time		_	3.3 ± 0.3	_	5.0	5.0	ne	
	^t rem		5.0 ± 0.5	_	5.0	5.0	ns	

AC Characteristics (Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol Test Condition				Ta = 25°C			Ta = -40~85°C		Unit
Characteristics	dymbol 1000 o	rest Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	Oill
			3.3 ± 0.3	15	_	7.5	11.9	1.0	14.0	ns
Propagation delay time	t _{pLH}		3.3 ± 0.3	50		10.0	15.4	1.0	17.5	
(CK - Q1)	tpHL	_	5.0 ± 0.5	15		4.8	7.3	1.0	8.5	113
			3.0 ± 0.3	50		6.3	9.3	1.0	10.5	
Propagation delay time	A+ .		3.3 ± 0.3	50		2.4	4.4	1.0	5.0	ns
$(Q_n - Q_n + 1)$	$\Delta t_{\sf pd}$	_	5.0 ± 0.5	50	_	1.6	3.1	1.0	3.5	115
	t _{pHL}	_	3.3 ± 0.3	15	_	8.3	12.8	1.0	15.0	- ns
Propagation delay time				50		10.8	16.3	1.0	18.5	
(CLR - Q)			5.0 ± 0.5	15		5.6	8.6	1.0	10.0	
				50		7.1	10.6	1.0	12.0	
			3.3 ± 0.3	15	75	140		75		- MHz
Maximum clock frequency				50	55	80		50		
Maximum clock frequency	f _{max}	_	50.05	15	150	210		125		
			5.0 ± 0.5	50	95	125		80		
Input capacitance	C _{IN}	-			_	4	10	_	10	pF
Power dissipation capacitance	C _{PD}			(Note)	_	21	_	_		pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

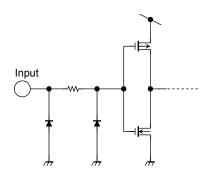
 $I_{CC \text{ (opr)}} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

Noise Characteristics (Input: $t_r = t_f = 3 \text{ ns}$)

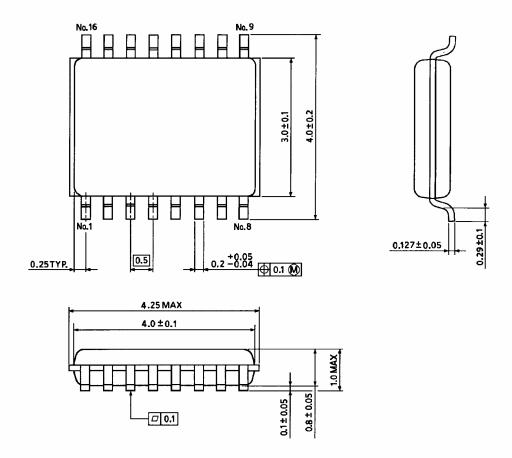
Characteristics	Symbol	Test Condition	Та		25°C	- Unit
Characteristics	Syllibol	rest Condition	V _{CC} (V)	Тур.	Limit	Offic
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	1.2	1.5	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-1.2	-1.5	V
Minimum high level dynamic input voltage $V_{\mbox{\scriptsize IH}}$	V _{IHD}	C _L = 50 pF	5.0	_	3.5	V
Minimum low level dynamic input voltage V _{IL}	V _{ILD}	C _L = 50 pF	5.0		1.5	V

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Input Equivalent Circuit



Package Dimensions



Weight: 0.02 g (typ.)

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